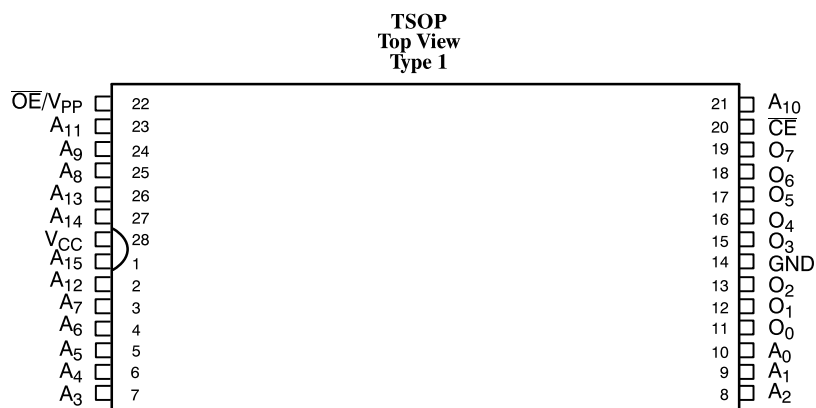




Pin Configurations (continued)


H512-4

Selection Guide

		27H512-25	27H512-30	27H512-35	27H512-45	27H512-55	27H512-70
Maximum Access Time (ns)		25	30	35	45	55	70
\overline{CE} Access Time (ns)	Com'l	30	35	35	45	55	70
	Mil			40	45	55	70
\overline{OE} Access Time (ns)	Com'l	12	15	15	15	20	25
	Mil			20	20	20	25
$I_{CC}^{[2]}$ (mA) Power Supply Current	Com'l	75	75	50	50	50	50
	Mil			85	60	60	60
$I_{SB}^{[3]}$ (mA) Stand-by Current	Com'l	15	15	15	15	15	15
	Mil			25	25	25	25

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature -65°C to $+150^{\circ}\text{C}$

Ambient Temperature with
Power Applied -55°C to $+125^{\circ}\text{C}$

Supply Voltage to Ground Potential -0.5V to $+7.0\text{V}$

DC Voltage Applied to Outputs
in High Z State -0.5V to $+5.5\text{V}$

DC Input Voltage -3.0V to $+7.0\text{V}$

Transient Input Voltage -3.0V for $<20\text{ ns}$

DC Program Voltage 13.0V

Notes:

2. $V_{CC} = \text{Max.}$, $I_{OUT} = 0\text{ mA}$, $f = 10\text{ MHz}$.

3. $V_{CC} = \text{Max.}$, $\overline{CE} = V_{IH}$.

UV Erasure 7258 Wsec/cm^2

Static Discharge Voltage $>2001\text{V}$
(per MIL-STD-883, Method 3015)

Latch-Up Current $>200\text{ mA}$

Operating Range

Range	Ambient Temperature	V_{CC}
Commercial	0°C to $+70^{\circ}\text{C}$	$5\text{V} \pm 10\%$
Industrial ^[4]	-40°C to $+85^{\circ}\text{C}$	$5\text{V} \pm 10\%$
Military ^[5]	-55°C to $+125^{\circ}\text{C}$	$5\text{V} \pm 10\%$

4. Contact a Cypress representative for industrial temperature range specification.

5. T_A is the "instant on" case temperature.

Electrical Characteristics Over the Operating Range^[6, 7]

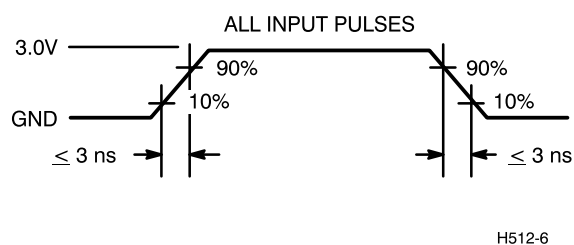
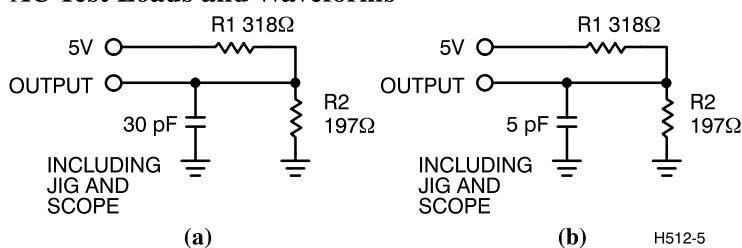
Parameter	Description	Test Conditions	27H512-25 27H512-30		27H512-35		27H512-45 27H512-55 27H512-70		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	
V _{OH}	Output HIGH Voltage	V _{CC} = Min., I _{OH} = -4.0 mA	2.4		2.4		2.4		V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 12.0 mA		0.45		0.45		0.45	V
V _{IH}	Input HIGH Level	Guaranteed Input Logical HIGH Voltage for All Inputs	2.0	V _{CC} +0.5	2.0	V _{CC} +0.5	2.0	V _{CC} +0.5	V
V _{IL}	Input LOW Level	Guaranteed Input Logical LOW Voltage for All Inputs		0.8		0.8		0.8	V
I _{IX}	Input Leakage Current	GND ≤ V _{IN} ≤ V _{CC}	-10	+10	-10	+10	-10	+10	μA
I _{OZ}	Output Leakage Current	GND ≤ V _{OUT} ≤ V _{CC} , Output Disable	-10	+10	-10	+10	-10	+10	μA
I _{CC}	Power Supply Current	V _{CC} =Max., I _{OUT} =0 mA, f=10 MHz	Com'l	75		50		50	mA
			Mil			85		60	mA
I _{SB}	Stand-By Current	V _{CC} =Max., CE = V _{IH}	Com'l	15		15		15	mA
			Mil			25		25	mA

Capacitance^[7]

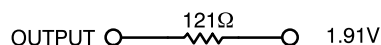
Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	T _A = 25°C, f = 1 MHz, V _{CC} = 5.0V	10	pF
C _{OUT}	Output Capacitance		10	pF

Notes:

6. See the last page of this specification for Group A subgroup testing information.
7. See Introduction to CMOS PROMs in this Data Book for general information on testing.

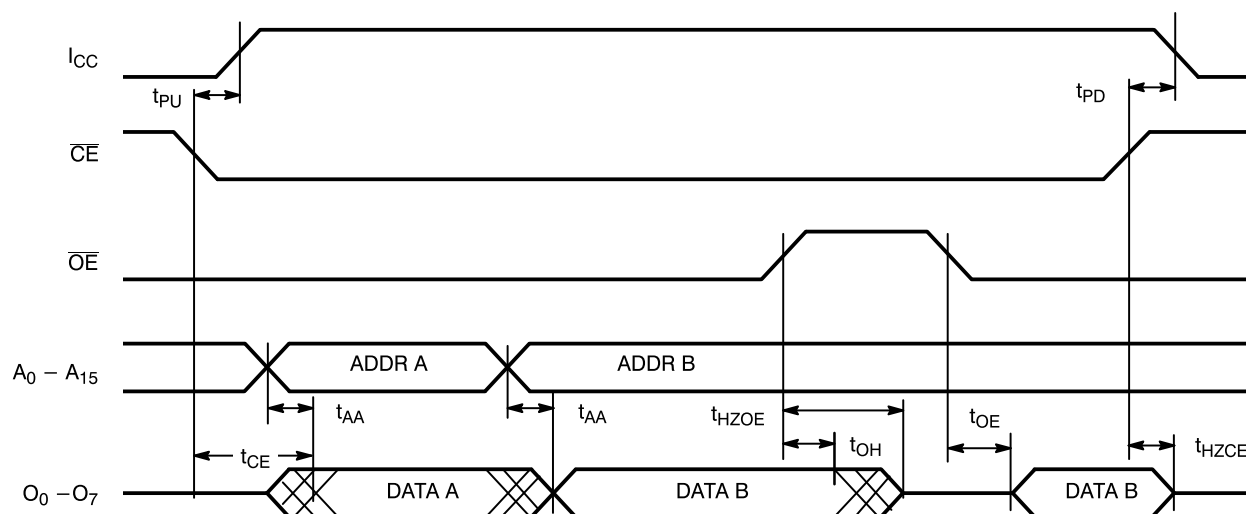
AC Test Loads and Waveforms


Equivalent to: THÉVENIN EQUIVALENT



Switching Characteristics Over the Operating Range

Parameter	Description	27H512–25		27H512–30		27H512–35		27H512–45		27H512–55		27H512–70		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t_{AA}	Address to Output Valid		25		30		35		45		55		70	ns
t_{OE}	\overline{OE} Active to Output Valid		12		15		15		15		20		25	ns
t_{HZOE}	\overline{OE} Inactive to High Z		12		15		15		15		20		25	ns
t_{CE}	\overline{CE} Active to Output Valid		30		35		35		45		55		70	ns
t_{HZCE}	\overline{CE} Inactive to High Z		12		15		15		15		20		25	ns
t_{PU}	\overline{CE} Active to Power-Up	0		0		0		0		0		0		ns
t_{PD}	\overline{CE} Inactive to Power-Down		30		35		40		40		50		60	ns
t_{OH}	Output Data Hold	0		0		0		0		0		0		ns

Switching Waveform


H512-7

Erase Characteristics

Wavelengths of light less than 4000 Angstroms begin to erase the CY27H512 in the windowed package. For this reason, an opaque label should be placed over the window if the EPROM is exposed to sunlight or fluorescent lighting for extended periods of time.

The recommended dose of ultraviolet light for erasure is a wavelength of 2537 Angstroms for a minimum dose (UV intensity multiplied by exposure time) of 25 Wsec/cm². For an ultraviolet lamp with a 12 mW/cm² power rating, the exposure time would be approximately 35 minutes. The CY27H512 needs to be within 1 inch of the lamp during erasure. Permanent damage may result if the

EPROM is exposed to high-intensity UV light for an extended period of time. 7258 Wsec/cm² is the recommended maximum dosage.

Programming Modes

Programming support is available from Cypress as well as from a number of third-party software vendors. For detailed programming information, including a listing of software packages, please see the PROM Programming Information located at the end of this section. Programming algorithms can be obtained from any Cypress representative.

Table 1. Programming Electrical Characteristics

Parameter	Description	Min.	Max.	Unit
V _{PP}	Programming Power Supply	12.5	13	V
I _{PP}	Programming Supply Current		50	mA
V _{IHP}	Programming Input Voltage HIGH	3.0	V _{CC}	V
V _{ILP}	Programming Input Voltage LOW	-0.5	0.4	V
V _{CCP}	Programming VCC	6.0	6.5	V

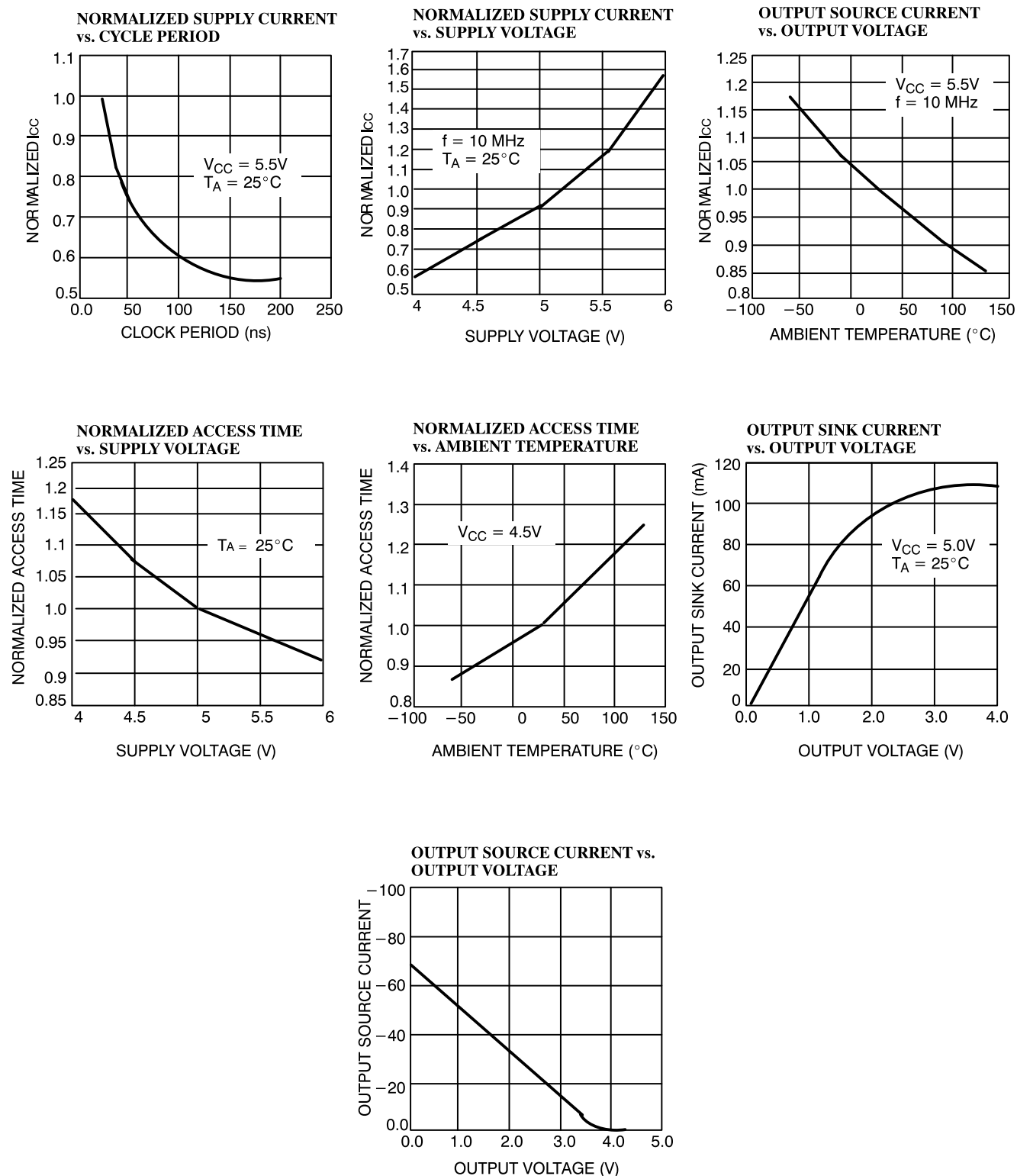
Table 2. Mode Selection

Mode	Pin Function ^[8]				
	\overline{CE}	\overline{OE}/V_{PP}	A ₀	A ₉	Data
Read	V _{IL}	V _{IL}	A ₀	A ₉	O ₇ – O ₀
Output Disable	X	V _{IH}	A ₀	A ₉	High Z
Stand-by	V _{IH}	X	X	X	High Z
Program	V _{ILP}	V _{PP}	A ₀	A ₉	D ₇ – D ₀
Program Verify	V _{ILP}	V _{ILP}	A ₀	A ₉	O ₇ – O ₀
Program Inhibit	V _{IHP}	V _{PP}	A ₀	A ₉	High Z
Signature Read (MFG)	V _{IL}	V _{IL}	V _{IL}	V _{HV} ^[9]	34H
Signature Read (DEV)	V _{IL}	V _{IL}	V _{IH}	V _{HV} ^[9]	1FH

Note:

8. X can be V_{IL} or V_{IH}.

9. V_{HV} = 12 ± 0.5V

Typical DC and AC Characteristics


Ordering Information^[10]

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
25	CY27H512–25HC	H65	32-Pin Windowed Leaded Chip Carrier	Commercial
	CY27H512–25JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY27H512–25ZC	Z28	28-Lead Thin Small Outline Package	
30	CY27H512–30HC	H65	32-Pin Windowed Leaded Chip Carrier	Commercial
	CY27H512–30JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY27H512–30PC	P15	28-Lead (600-Mil) Molded DIP	
	CY27H512–30WC	W16	28-Lead (600-Mil) Windowed CerDIP	
	CY27H512–30ZC	Z28	28-Lead Thin Small Outline Package	
35	CY27H512–35HC	H65	32-Pin Windowed Leaded Chip Carrier	Commercial
	CY27H512–35JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY27H512–35PC	P15	28-Lead (600-Mil) Molded DIP	
	CY27H512–35WC	W16	28-Lead (600-Mil) Windowed CerDIP	
	CY27H512–35ZC	Z28	28-Lead Thin Small Outline Package	
	CY27H512–35HMB	H65	32-Pin Windowed Leaded Chip Carrier	Military
	CY27H512–35LMB	L55	32-Pin Rectangular Leadless Chip Carrier	
	CY27H512–35QMB	Q55	32-Pin Windowed Rectangular Leadless Chip Carrier	
45	CY27H512–45HC	H65	32-Pin Windowed Leaded Chip Carrier	Commercial
	CY27H512–45JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY27H512–45PC	P15	28-Lead (600-Mil) Molded DIP	
	CY27H512–45WC	W16	28-Lead (600-Mil) Windowed CerDIP	
	CY27H512–45ZC	Z28	28-Lead Thin Small Outline Package	
	CY27H512–45DMB	D16	28-Lead (600-Mil) CerDIP	Military
	CY27H512–45HMB	H65	32-Pin Windowed Leaded Chip Carrier	
	CY27H512–45LMB	L55	32-Pin Rectangular Leadless Chip Carrier	
	CY27H512–45QMB	Q55	32-Pin Windowed Rectangular Leadless Chip Carrier	
	CY27H512–45WMB	W16	28-Lead (600-Mil) Windowed CerDIP	
55	CY27H512–55HC	H65	32-Pin Windowed Leaded Chip Carrier	Commercial
	CY27H512–55JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY27H512–55PC	P15	28-Lead (600-Mil) Molded DIP	
	CY27H512–55WC	W16	28-Lead (600-Mil) Windowed CerDIP	
	CY27H512–55ZC	Z28	28-Lead Thin Small Outline Package	
	CY27H512–55DMB	D16	28-Lead (600-Mil) CerDIP	Military
	CY27H512–55HMB	H65	32-Pin Windowed Leaded Chip Carrier	
	CY27H512–55LMB	L55	32-Pin Rectangular Leadless Chip Carrier	
	CY27H512–55QMB	Q55	32-Pin Windowed Rectangular Leadless Chip Carrier	
	CY27H512–55WMB	W16	28-Lead (600-Mil) Windowed CerDIP	

Notes:

10. Most of the above products are available in industrial temperature range. Contact a Cypress representative for specifications and product availability.



Ordering Information^[10] (continued)

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
70	CY27H512–70HC	H65	32-Pin Windowed Leaded Chip Carrier	Commercial
	CY27H512–70JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY27H512–70PC	P15	28-Lead (600-Mil) Molded DIP	
	CY27H512–70WC	W16	28-Lead (600-Mil) Windowed CerDIP	
	CY27H512–70ZC	Z28	28-Lead Thin Small Outline Package	
	CY27H512–70DMB	D16	28-Lead (600-Mil) CerDIP	Military
	CY27H512–70HMB	H65	32-Pin Windowed Leaded Chip Carrier	
	CY27H512–70LMB	L55	32-Pin Rectangular Leadless Chip Carrier	
	CY27H512–70QMB	Q55	32-Pin Windowed Rectangular Leadless Chip Carrier	
	CY27H512–70WMB	W16	28-Lead (600-Mil) Windowed CerDIP	

MILITARY SPECIFICATIONS

Group A Subgroup Testing

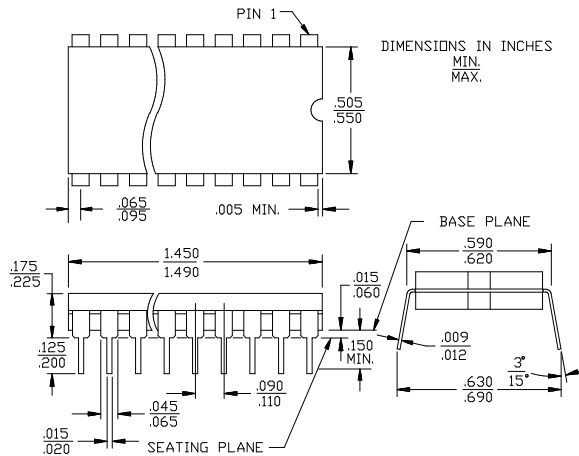
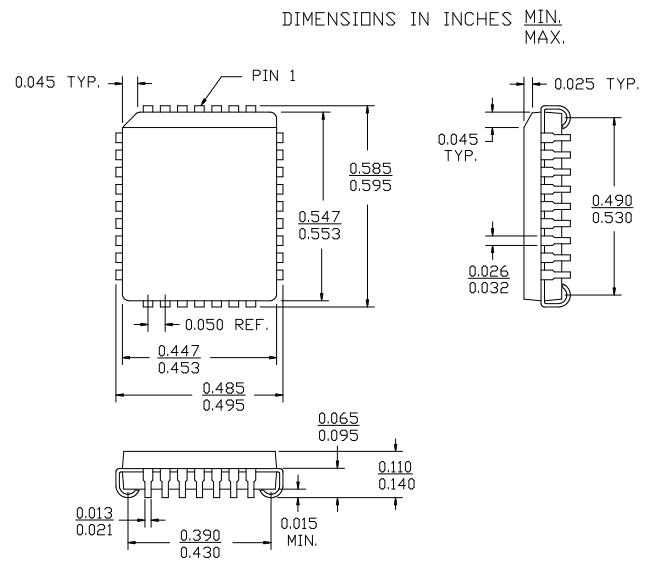
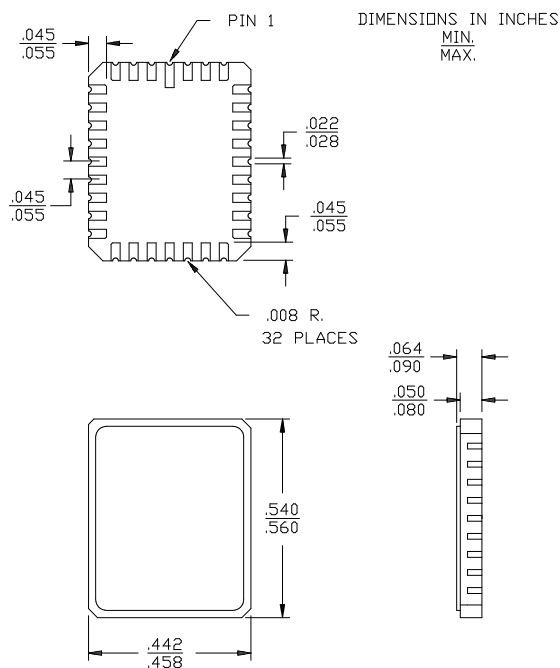
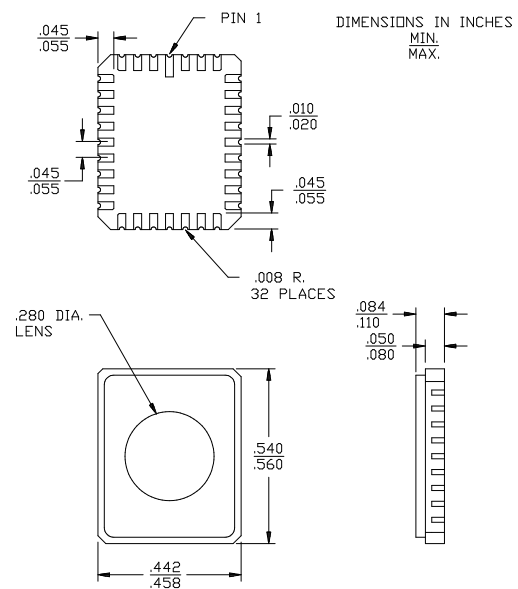
DC Characteristics

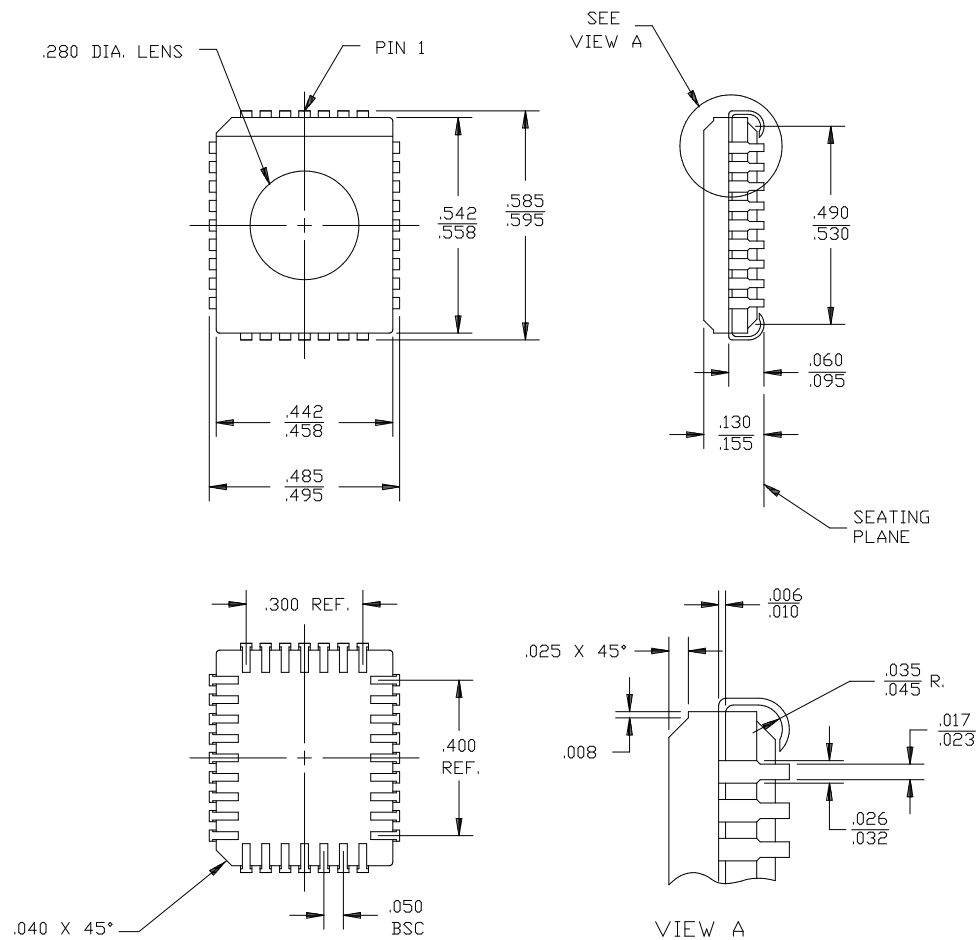
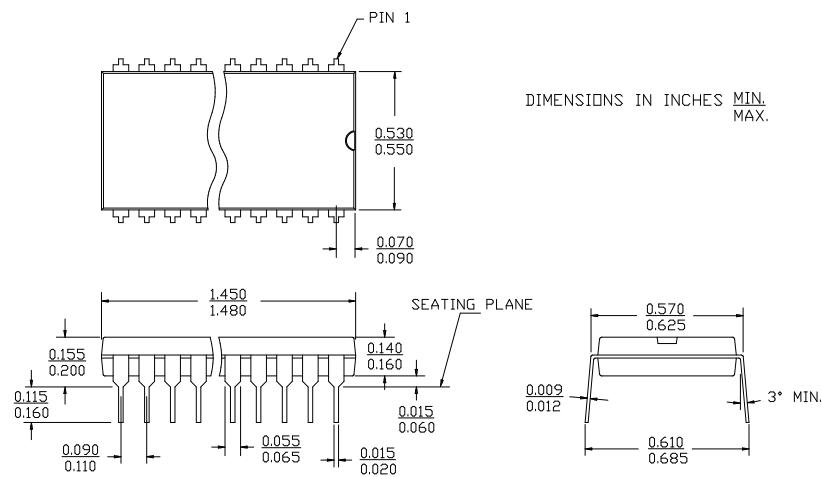
Parameter	Subgroups
V _{OH}	1, 2, 3
V _{OL}	1, 2, 3
V _{IH}	1, 2, 3
V _{IL}	1, 2, 3
I _{IX}	1, 2, 3
I _{OZ}	1, 2, 3
I _{CC}	1, 2, 3
I _{SB}	1, 2, 3

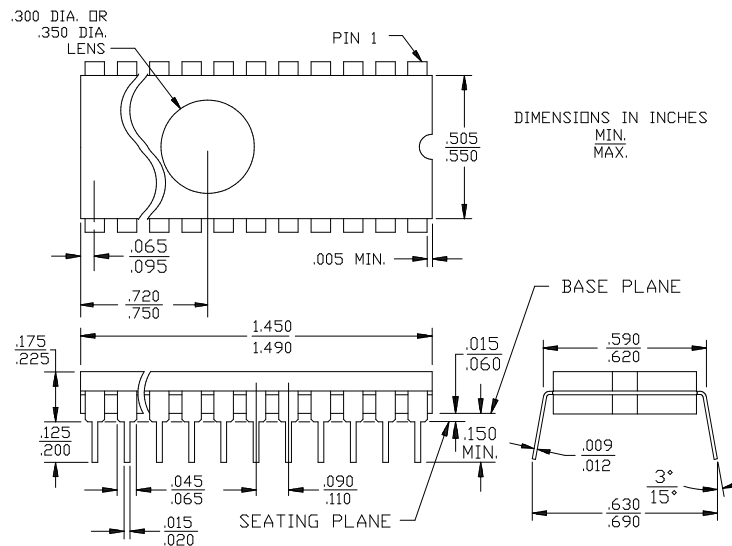
Switching Characteristics

Parameter	Subgroups
t _{AA}	7, 8, 9, 10, 11
t _{OE}	7, 8, 9, 10, 11
t _{CE}	7, 8, 9, 10, 11

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Package Diagrams (continued)
28-Lead (600-Mil) CerDIP D16
 MIL-STD-1835 D-10 Config. A

32-Lead Plastic Leaded Chip Carrier J65

32-Pin Rectangular Leadless Chip Carrier L55
 MIL-STD-1835 C-12

32-Pin Windowed Rectangular Leadless Chip Carrier Q55
 MIL-STD-1835 C-12


Package Diagrams
32-Pin Windowed Leaded Chip Carrier H65

28-Lead (600-Mil) Molded DIP P15


Package Diagrams
28-Lead (600-Mil) Windowed CerDIP W16
 MIL-STD-1835 D-10 Config. A

28-Lead Thin Small Outline Package Z28

 DIMENSION IN MM (INCH)
 MAX.
 MIN.
